



PC Board Layout
Component Side Shown

NOTES:
MATERIAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0
- 2 CONTACT MATERIAL : PHOSPHOR BRONZE t=0.30mm.
- 3 PLATING : SELECTING GOLD PLATING 3u"~50u" OVER NICKEL IN CONTACT AREA 150u" TIN PLATING OVER NICKEL IN SOLDER AREA

4. SHIELD
ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
- 2 CURRENT RATING : 1.5 AMP
- 3 CONTACT RESISTANCE: 30 MILLI OHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @500V DC.
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz 1MIN.

MECHANICAL:

1. DURABILITY : 750 CYCLES MIN.
 2. PCB RETENTION PRE-SOLDER: 1 LB MIN
- ENVIRONMENTAL:
1. STORAGE : -40° C TO 85° C
2. OPERATION : 0° C TO 70° C

TOLERANCE TABLE

.0	±0.20
.00	±0.10
.000	±0.05

APPROVED:	DATE:	<p>C 深圳市灿科盟实业有限公司 kmtw CHANKLEMENT INDUSTRYCO., LTD</p>												
CHECKED:	DATE:													
DRAWN:	DATE:	<p>TITLE: 网口插座: RJ45-8P/8C 斜口侧插 带屏蔽 白色 (52C-1X1-8P8C-S)</p>												
ZYJ	2018-10-28	<table border="1"> <tr> <td>P/N</td> <td>R-RJ45R08P-B008</td> </tr> <tr> <td>UNIT</td> <td>mm</td> </tr> <tr> <td>SCALE</td> <td>Free</td> </tr> <tr> <td>FILE NO.</td> <td>Ckmtw-RJ45-0177</td> </tr> <tr> <td>REV.</td> <td>A</td> </tr> <tr> <td></td> <td>HY04</td> </tr> </table>	P/N	R-RJ45R08P-B008	UNIT	mm	SCALE	Free	FILE NO.	Ckmtw-RJ45-0177	REV.	A		HY04
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